NUD3048

FET Switch 100 V, 800 mΩ, N–Channel, TSOP–6

The NUD3048 provides a single device solution for a number of applications requiring a low power, high voltage, FET switch. The package includes a gate resistor and gate to source zener clamp. This switch can accommodate a wide range of input voltages, making it compatible with most current logic levels. Its 100 V rating makes it compatible with 48 V telecom applications.

Features

- 100 V Rating On Gate 2
- Integrated 100 k Rg Option
- Integrated ESD Diode Protection
- Low Threshold Voltage
- Pb–Free Package is Available

Typical Applications

- FET Switch
- Inverter
- Level Shifter
- Inrush Limiter
- Relay Driver

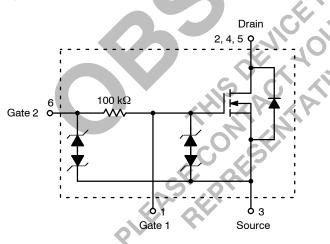
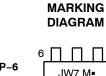


Figure 1. Block Diagram

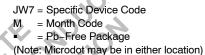


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ORDERING INFORMATION

-	Device	Package	Shipping [†]
	NUD3048MT1	TSOP-6	3000 / Tape & Reel
	NUD3048MT1G	TSOP-6 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

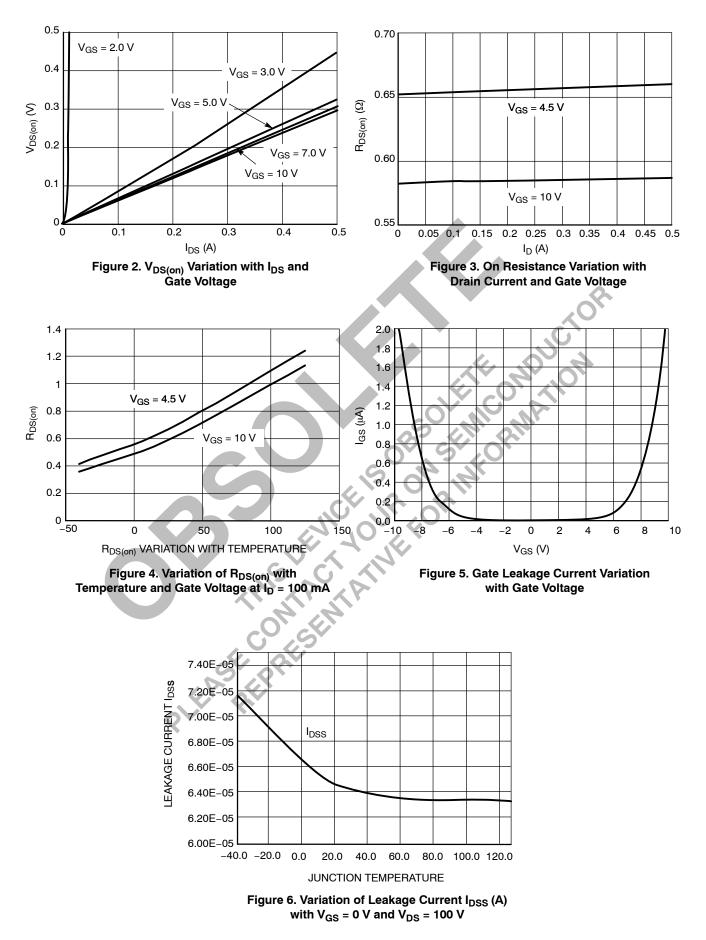
Symbol	Rating	Value	Unit
V _{DSS}	Drain to Source Voltage – Continuous	100	V
V _{G1SS}	Gate to Source Voltage – Continuous @ 1.0 mA	15	V
۱ _D	Drain Current – Continuous (T _A =25°C) (Note 1) (Note 2)	0.7 1.2	A
PD	Power Dissipation ($T_A = 25^{\circ}C$) (Note 1) (Note 2)	0.66 1.56	W
V _{G2SS}	Gate Resistor to Source Voltage – Continuous	100	V
T _{Jmax}	Maximum Junction Temperature	150	°C
R_{\thetaJA}	Thermal Impedance (Junction-to-Ambient) (Note 1) Thermal Impedance (Junction-to-Ambient) (Note 2)	190 80	°C/W
ESD	Human Body Model (HBM) Class 2 Machine Model Class A According to EIA/JESD22/A114 Specification	2000 160	V V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			.0.		
Drain to Source Leakage Current (V_{DS} = 80 V, V_{GS} = 0 V)	IDSS		20	100	μA
Gate Body Leakage Current ($V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V}$) ($V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V}, T_J = 125^{\circ}\text{C}$)	I _{GSS}		3.0 6.0	10 20	μΑ
ON CHARACTERISTICS		2			•
Gate Threshold Voltage (I _D = 1.0 mA)	V _{GS}	1.3	1.7	2.0	V
Drain to Source Resistance (V_{GS} = 4.5 V, I_D = 100 mA)	R _{DS(on)}	-	0.65	0.82	Ω
Drain to Source Resistance (V _{GS} = 10 V, I _D = 100 mA)	R _{DS(on)}	-	0.6	0.72	Ω
DYNAMIC CHARACTERISTICS	\sim				•
Input Capacitance (V_{DS} = 5.0 V, V_{GS} = 0 V, f = 10 kHz)	C _{iss}	-	135	-	pF
Output Capacitance (V_{DS} = 5.0 V, V_{GS} = 0 V, f = 10 kHz)	C _{oss}	-	75	-	pF
Transfer Capacitance (V_{DS} = 5.0 V, V_{GS} = 0 V, f = 10 kHz)	C _{rss}	-	26	-	pF
GATE BIAS CHARACTERISTICS					
Gate Resistor	R _G	75	100	125	kΩ
Gate Zener Breakdown Voltage (Iz = 1.0 mA) (Note 3)	Vz	15	17	-	V
Gate Zener Breakdown Voltage (Iz = 3.0 mA) (Note 4)		100	115	-	

Min pad, 1 oz. Cu.
1 inch pad, 1 oz Cu.
Measured from gate 1 to source.
Measured from gate 2 to source.

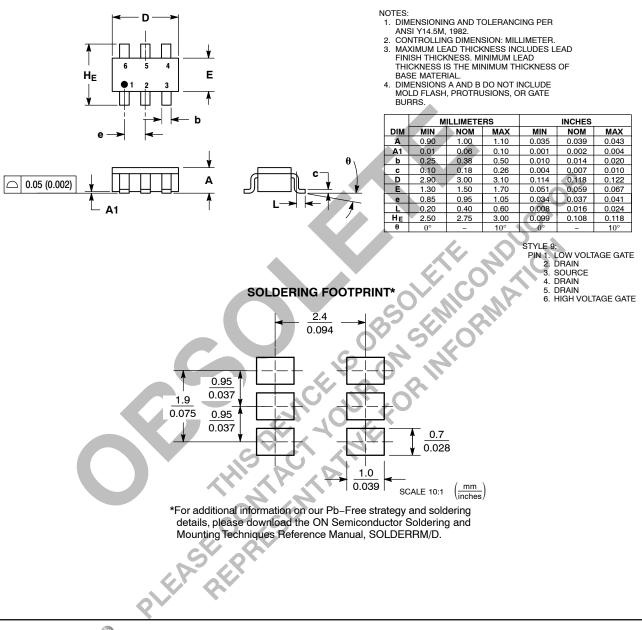
NUD3048



NUD3048

PACKAGE DIMENSIONS

TSOP-6 CASE 318G-02 ISSUE P



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